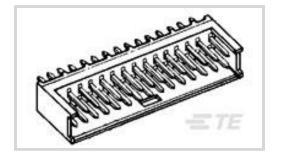
280509-2 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 280509-2 PCB Mount Header, Vertical, Board-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **18**

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Partially Shrouded



Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
PCB Mount Orientation	Vertical	
Number of Positions	18	
Number of Rows	2	
Electrical Characteristics		
Dielectric Withstanding Voltage (Max)	750 V	
Body Features		
Connector Profile	Standard	
Primary Product Color	Black	
Contact Features		
PCB Contact Termination Area Plating Material Thickness	2.5 µm	
Contact Shape & Form	Round	

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Contact Mating Area Plating Material Finish	Bright	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Brass	
Contact Mating Area Plating Material	Gold	
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]	
Contact Type	Pin	
Termination Features		
Termination Post & Tail Length	3.5 mm[.138 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Retention	With	
Panel Mount Feature	Without	
Mating Alignment	With	
Mating Alignment Type	Polarization	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
eenneeter meanting type		

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	Thermoplastic	
Dimensions		
Row-to-Row Spacing	2.54 mm[.1 in]	
Usage Conditions		
Housing Temperature Rating	Standard	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Circuit Application	Power & Signal	
Packaging Features		
Packaging Quantity	400	
Packaging Type	Box	

Product Compliance

PCB Mount Header, Vertical, Board-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-



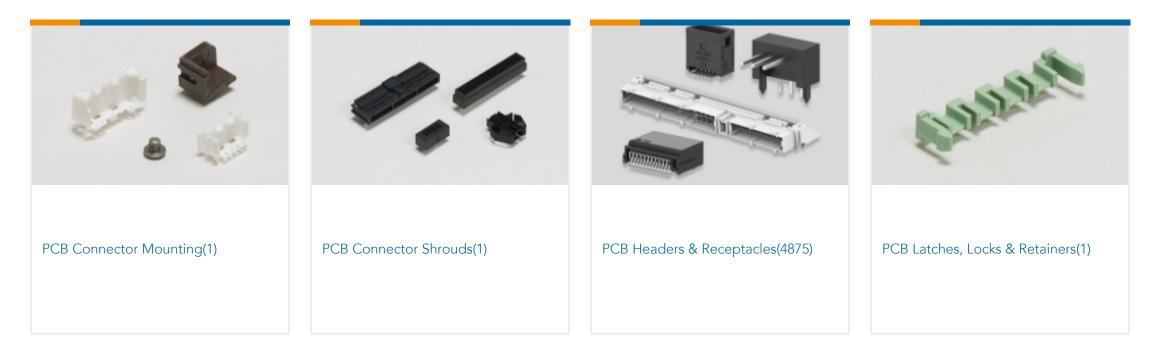
Compatible Parts

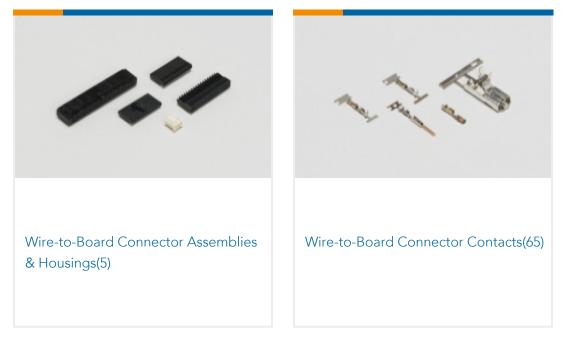


Also in the Series AMPMODU Headers

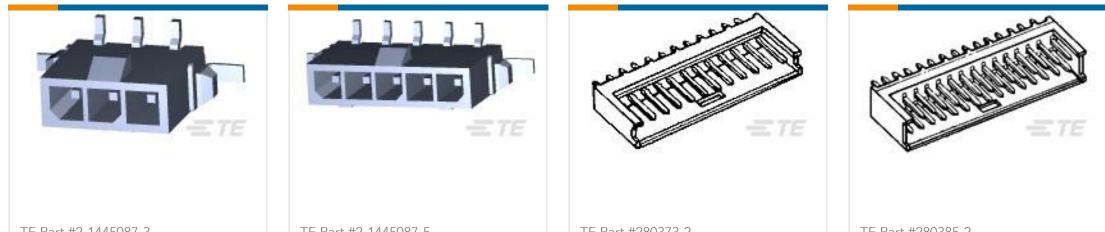
PCB Mount Header, Vertical, Board-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers







Customers Also Bought



TE Part #2-1445087-3 MICRO MNL HDR ASSY S/ROW AU LF	TE Part #2-1445087-5 MICRO MNL HDR ASSY S/ROW AU LF	TE Part #280373-2 8P AMPMODU II SHRD HDR, ST, 0.38 AU	TE Part #280385-2 2X8P AMPMODU II SHRD HDR,ST,0.38 AU
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TE Part #280384-2 2X4P AMPMODU II SHRD HDR,ST,0.38 AU	TE Part #3-794637-8 08P MICRO MNL ASSY,VRT,SMT LF	TE Part #280387-2 2X15P MODU II SHRD HDR,ST,0.38AU	TE Part #6-2176455-0 CPF 0402 453K 0.1% 25ppm 1K RL

TE Part #284308-E STVC 96 F ABC VVV 7-00 TL 4,0 * 247 E007

Documents

PCB Mount Header, Vertical, Board-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



Product Drawings 18 POS .100DR MODU-English **CAD** Files 3D PDF 3D Customer View Model ENG_CVM_CVM_280509-2_S_c-280509-2-s.2d_dxf.zip English Customer View Model ENG_CVM_CVM_280509-2_S_c-280509-2-s.3d_igs.zip English Customer View Model ENG_CVM_CVM_280509-2_S_c-280509-2-s.3d_stp.zip English By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance

TE Material Declaration

English